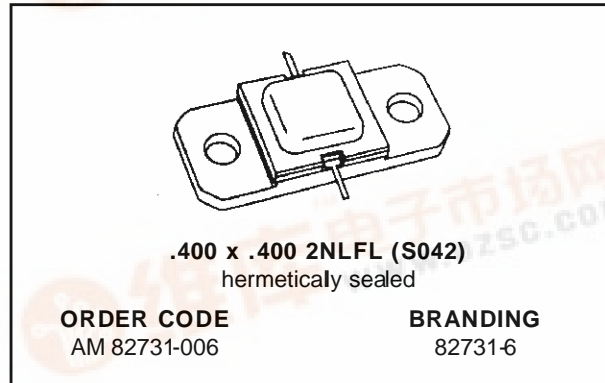




AM82731-006

RF & MICROWAVE TRANSISTORS S-BAND RADAR APPLICATIONS

- REFRACTORY/GOLD METALLIZATION
- EMITTER SITE BALLASTED
- 5:1 VSWR CAPABILITY
- LOW THERMAL RESISTANCE
- INPUT/OUTPUT IMPEDANCE MATCHING
- OVERLAY GEOMETRY
- METAL/CERAMIC HERMETIC PACKAGE
- P_{OUT} = 5.5 W. MIN. WITH 5.6 dB GAIN
- BANDWIDTH = 400 MHz

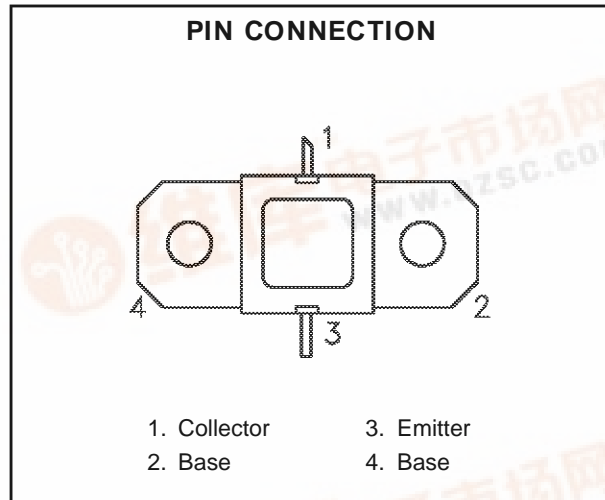


DESCRIPTION

The AM82731-006 device is a medium power silicon bipolar NPN transistor specifically designed for S-Band radar pulsed driver applications.

This device is capable of operation over a wide range of pulse widths, duty cycles, and temperatures and can withstand a 5:1 output VSWR. Low RF thermal resistance, refractory/gold metallization, and automatic wire bonding techniques ensure high reliability and product consistency.

The AM82731-006 is supplied in the hermetic metal/ceramic package with internal input/output impedance matching circuitry, and is intended for military and other high reliability applications.



ABSOLUTE MAXIMUM RATINGS (T_{case} = 25°C)

Symbol	Parameter	Value	Unit
P _{DISS}	Power Dissipation* (T _C ≤ 100°C)	40	W
I _C	Device Current*	1.8	A
V _{CC}	Collector-Supply Voltage*	34	V
T _J	Junction Temperature (Pulsed RF Operation)	250	°C
T _{STG}	Storage Temperature	- 65 to +200	°C

THERMAL DATA

R _{TH(j-c)}	Junction-Case Thermal Resistance	3.75	°C/W
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*Applies only to rated RF amplifier operation



AM82731-006

ELECTRICAL SPECIFICATIONS (T_{case} = 25°C)

STATIC

Symbol	Test Conditions		Value			Unit
			Min.	Typ.	Max.	
BV _{CBO}	I _C = 5mA	I _E = 0mA	50	—	—	V
BV _{EBO}	I _E = 1mA	I _C = 0mA	3.5	—	—	V
BV _{CER}	I _C = 5mA	R _{BE} = 10Ω	50	—	—	V
I _{CES}	V _{CE} = 30V		—	—	4	mA
h _{FE}	V _{CE} = 5V	I _C = 500mA	10	—	—	—

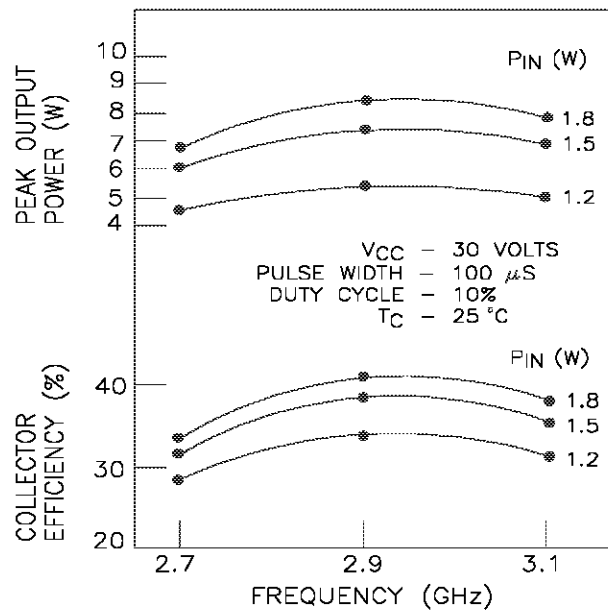
DYNAMIC

Symbol	Test Conditions			Value			Unit
				Min.	Typ.	Max.	
P _{OUT}	f = 2.7 — 3.1GHz	P _{IN} = 1.5W	V _{CC} = 30V	5.5	6.0	—	W
η _C	f = 2.7 — 3.1GHz	P _{IN} = 1.5W	V _{CC} = 30V	27	32	—	%
GPB	f = 2.7 — 3.1GHz	P _{IN} = 1.5W	V _{CC} = 30V	5.6	6.0	—	dB

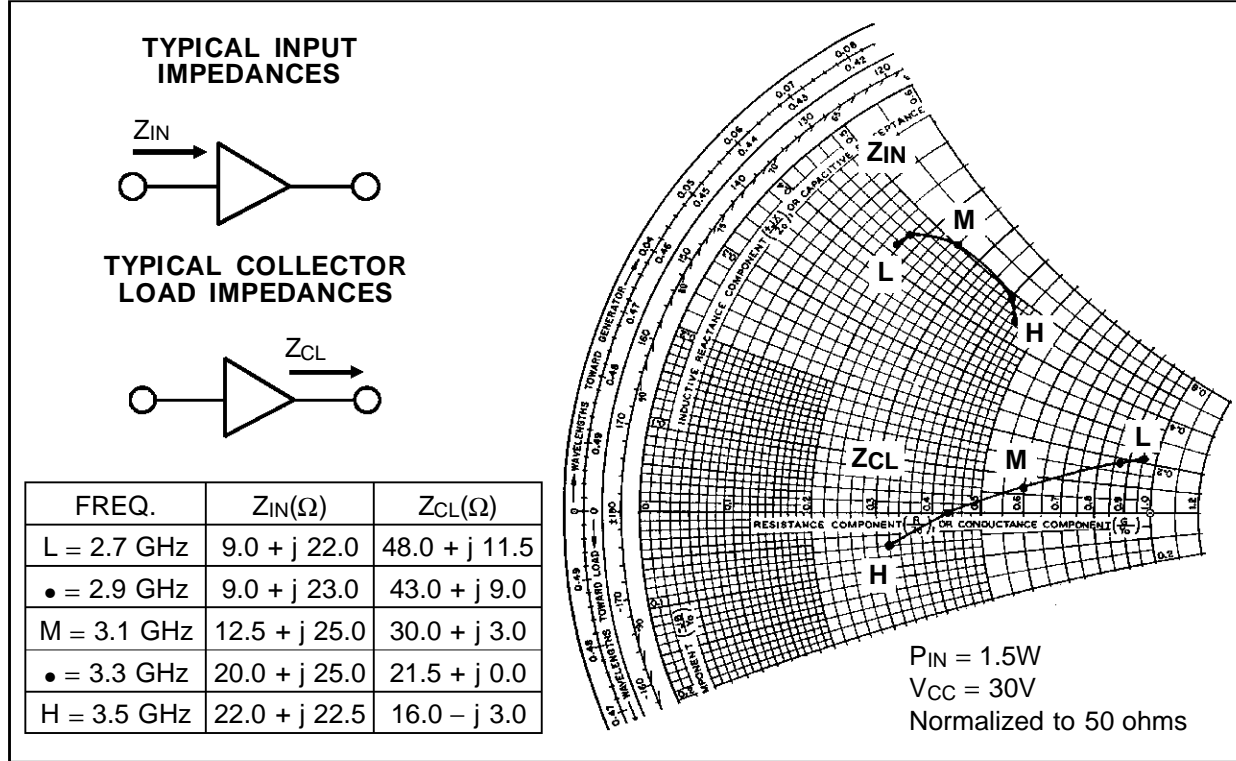
Note: Pulse Width = 100μS
Duty Cycle = 10%

TYPICAL PERFORMANCE

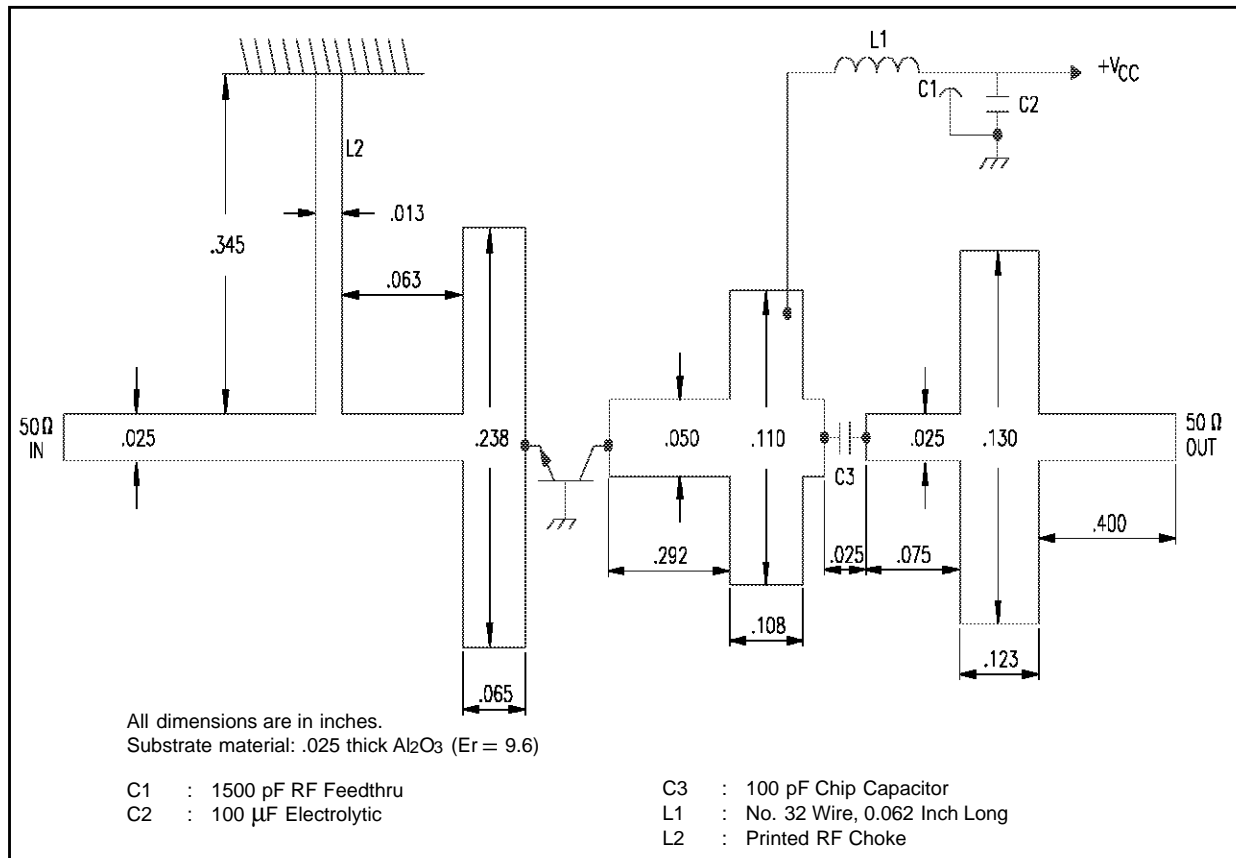
TYPICAL BROADBAND PERFORMANCE



IMPEDANCE DATA



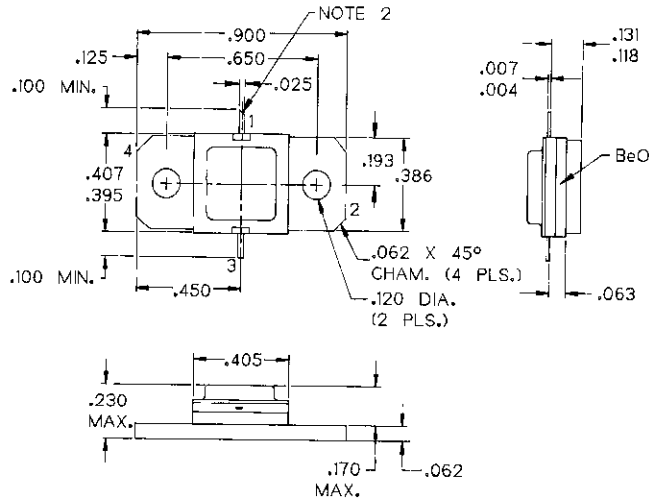
TEST CIRCUIT



AM82731-006

PACKAGE MECHANICAL DATA

Ref.: Dwg. No.: J113214F



NOTES:

1. ALL TOLERANCE $\pm .010$ EXCEPT WHERE NOTED;
DIMENSIONS IN INCHES.
2. COLLECTOR LEAD SLANT CUT.

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